SN54AHCT123A, SN74AHCT123A DUAL RETRIGGERABLE MONOSTABLE MULTIVIBRATORS

SCLS420G - JUNE 1998 - REVISED APRIL 2003

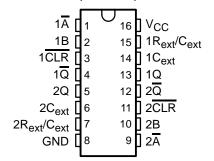
- Inputs Are TTL-Voltage Compatible
- Schmitt-Trigger Circuitry On A, B, and CLR Inputs for Slow Input Transition Rates
- Edge Triggered From Active-High or Active-Low Gated Logic Inputs
- Retriggerable for Very Long Output Pulses
- Overriding Clear Terminates Output Pulse
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)

description/ordering information

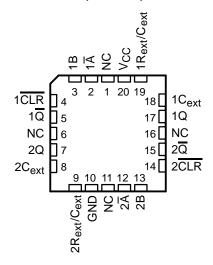
These edge-triggered multivibrators feature output pulse-duration control by three methods. In the first method, the \overline{A} input is low, and the B input goes high. In the second method, the B input is high, and the \overline{A} input goes low. In the third method, the \overline{A} input is low, the B input is high, and the clear (\overline{CLR}) input goes high.

The output pulse duration is programmed by selecting external resistance and capacitance values. The external timing capacitor must be connected between C_{ext} and $R_{\text{ext}}/C_{\text{ext}}$ (positive) and an external resistor connected between $R_{\text{ext}}/C_{\text{ext}}$ and V_{CC} . To obtain variable pulse durations, connect an external variable resistance between $R_{\text{ext}}/C_{\text{ext}}$ and V_{CC} . The output pulse duration also can be reduced by taking $\overline{\text{CLR}}$ low.

SN54AHCT123A . . . J OR W PACKAGE SN74AHCT123A . . . D, DB, DGV, N, OR PW PACKAGE (TOP VIEW)



SN54AHCT123A . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

ORDERING INFORMATION

TA	PACK	\GE†	ORDERABLE PART NUMBER	TOP-SIDE MARKING
	PDIP – N	Tube	SN74AHCT123AN	SN74AHCT123AN
	SOIC - D	Tube	SN74AHCT123AD	AHCT123A
-40°C to 85°C	30IC = D	Tape and reel	SN74AHCT123ADR	AUCTISA
-40 C to 65 C	SSOP – DB	Tape and reel	SN74AHCT123ADBR	HB123A
	TSSOP – PW	Tape and reel	SN74AHCT123APWR	HB123A
	TVSOP - DGV	Tape and reel	SN74AHCT123ADGVR	HB123A
	CDIP – J	Tube	SNJ54AHCT123AJ	SNJ54AHCT123AJ
–55°C to 125°C	CFP – W	Tube	SNJ54AHCT123AW	SNJ54AHCT123AW
	LCCC – FK	Tube	SNJ54AHCT123AFK	SNJ54AHCT123AFK

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



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description/ordering information(continued)

Pulse triggering occurs at a particular voltage level and is not directly related to the transition time of the input pulse. The \overline{A} , B, and \overline{CLR} inputs have Schmitt triggers with sufficient hysteresis to handle slow input transition rates with jitter-free triggering at the outputs.

Once triggered, the basic pulse duration can be extended by retriggering the gated low-level-active (\overline{A}) or high-level-active (B) input. Pulse duration can be reduced by taking \overline{CLR} low. \overline{CLR} input can be used to override \overline{A} or B inputs. The input/output timing diagram illustrates pulse control by retriggering the inputs and early clearing.

The variance in output pulse duration from device to device typically is less than $\pm 0.5\%$ for given external timing components. An example of this distribution for the 'AHCT123A is shown in Figure 10. Variations in output pulse duration versus supply voltage and temperature are shown in Figure 6.

During power up, Q outputs are in the low state, and \overline{Q} outputs are in the high state. The outputs are glitch free, without applying a reset pulse.

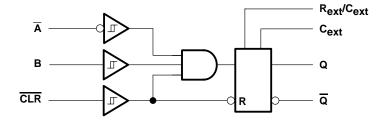
For additional application information on multivibrators, see the application report, *Designing With the SN74AHC123A and SN74AHCT123A*, literature number SCLA014.

FUNCTION TABLE (each multivibrator)

	NPUTS	OUTI	PUTS	
CLR	Ā	В	Q	Ø
L	Χ	Х	L	Н
Х	Н	X	L†	H [†]
Х	Χ	L	L†	H [†]
Н	L	\uparrow	Л	Т
Н	\downarrow	Н	л	П
↑	L	Н	л	u

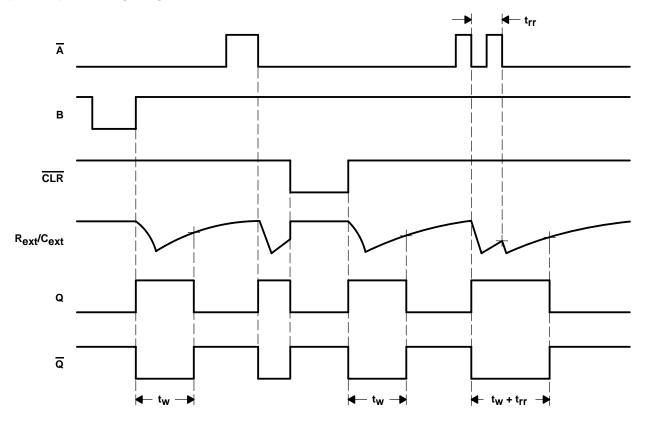
[†]These outputs are based on the assumption that the indicated steady-state conditions at the A and B inputs have been set up long enough to complete any pulse started before the setup.

logic diagram, each multivibrator (positive logic)





input/output timing diagram



absolute maximum ratings over operating free-air temperature (unless otherwise noted)†

Supply voltage range, V _{CC} (see Note 1)		–0.5 V to 7 V
Input voltage range, V _I (see Note 2)		–0.5 V to 7 V
Output voltage range, VO (see Note 1)		-0.5 V to V _{CC} + 0.5 V
Input clamp current, I _{IK} (V _I < 0)		–20 mA
Output clamp current, I _{OK} (V _O < 0 or V _O > V _{CO}	c)	$\dots \dots \pm 20 \text{ mA}$
Continuous output current, I_O ($V_O = 0$ to V_{CC})		$\dots \dots \pm 25 \text{ mA}$
Continuous current through V _{CC} or GND		$\dots \dots \pm 50 \text{ mA}$
Package thermal impedance, θ_{JA} (see Note 3):	: D package	73°C/W
	DB package	82°C/W
	DGV package	120°C/W
	N package	67°C/W
	PW package	108°C/W
Storage temperature range, T _{stg}		\dots -65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. Voltage values are with respect to the network ground terminal.

- 2. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
- 3. The package thermal impedance is calculated in accordance with JESD 51-7.



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recommended operating conditions (see Note 4)

		SN54AHC	T123A	SN74AH0	T123A	UNIT
		MIN	MAX	MIN	MAX	UNIT
Vcc	Supply voltage	4.5	5.5	4.5	5.5	V
VIH	High-level input voltage	2		2		V
V _{IL}	Low-level input voltage		0.8		0.8	V
٧ _I	Input voltage	0	5.5	0	5.5	V
٧o	Output voltage	0	Vcc	0	Vcc	V
IOH	High-level output current		-8		-8	mA
l _{OL}	Low-level output current		8		8	mA
R _{ext}	External timing resistance	1k		1k		Ω
Δt/ΔV _{CC}	Power-up ramp rate	1		1	·	ms/V
TA	Operating free-air temperature	-55	125	-40	85	°C

NOTE 4: Unused R_{ext}/C_{ext} terminals should be left unconnected. All remaining unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DA.	RAMETER	TEST CONDITIONS	V	T,	4 = 25°(3	SN54AHC	T123A	SN74AHC	T123A	UNIT
PA	KAWEIEK	TEST CONDITIONS	VCC	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
VOH		I _{OH} = -50 μA	4.5 V	4.4	4.5		4.4		4.4		٧
VOH		I _{OH} = –8 mA	4.5 V	3.94			3.8		3.8		V
\/a:		I _{OL} = 50 μA	4.5 V			0.1		0.1		0.1	V
VOL		$I_{OL} = 8 \text{ mA}$	4.5 V			0.36		0.5		0.44	V
	R _{ext} /C _{ext} †	$V_I = V_{CC}$ or GND	5.5 V			±0.25		±2.5		±2.5	
lį	Ā, B <u>,</u> and CLR	$V_I = V_{CC}$ or GND	0 V to 5.5 V			±0.1		±1*		±1	μΑ
Icc	Quiescent	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			4		40		40	μΑ
Icc	Active state (per circuit)	$V_I = V_{CC}$ or GND, $R_{ext}/C_{ext} = 0.5 V_{CC}$	5.5 V		560	750		975		975	μΑ
Δlcc	‡	One input at 3.4 V, Other inputs at V _{CC} or GND	5.5 V			1.35		1.5		1.5	mA
Ci		$V_I = V_{CC}$ or GND	5 V		1.9	10				10	pF

 $[\]star$ On products compliant to MIL-PRF-38535, this parameter is not production tested at $V_{CC} = 0 \text{ V}$.

timing requirements over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

			TEST CONDITIONS	T _A = 25°C			SN54AHC	T123A	SN74AHCT123A		UNIT
			TEST CONDITIONS	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
<u>.</u>	Pulse	CLR		5			5		5		20
t _W	duration	A or B trigger		5			5		5		ns
Γ.	Delle e este		$R_{ext} = 1 \text{ k}\Omega, C_{ext} = 100 \text{ pF}$	§	60		§		§		ns
۲rr	t _{rr} Pulse retrigger t		R_{ext} = 1 kΩ, C_{ext} = 0.01 μF	§	1.5		§		§		μs

[§] See retriggering data in the application information section.



[†] This test is performed with the terminal in the off-state condition.

[‡]This is the increase in supply current for each input at one of the specified TTL voltage levels rather than 0 V or VCC.

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switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

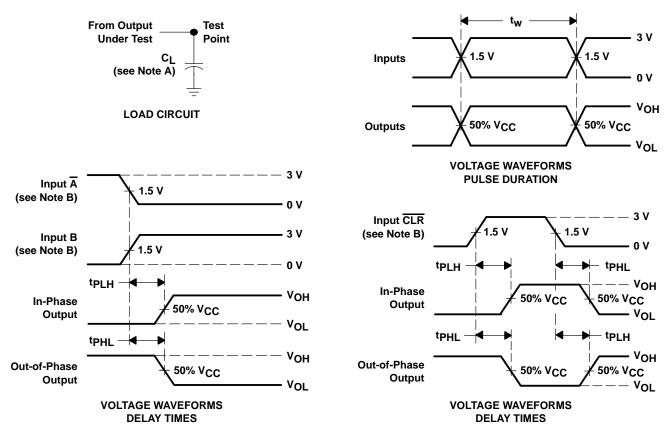
	FROM	то	TEST	T,	λ = 25°C	;	SN54AHC	T123A	SN74AHC	T123A	
PARAMETER	(INPUT)	(OUTPUT)	CONDITIONS	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
tPLH		0 0	C: -15 pE		5.3*	10*	1*	13*	1	11	ns
tPHL	A or B	Q or Q	C _L = 15 pF		5.3*	10*	1*	13*	1	11	ns
t _{PLH}	CLR	0 *** 0	C _L = 15 pF		7.7*	12*	1*	15*	1	13	ns
tPHL	CLR	Q or Q	CL = 15 pr		7.7*	12*	1*	15*	1	13	IIS
tPLH	<u> </u>	0 0	C: -15 pE		8*	13*	1*	16*	1	14	ns
tPHL	CLR trigger	Q or Q	C _L = 15 pF		8*	13*	1*	16*	1	14	115
tPLH	D	0	C: - 50 pE		6.8	11	1	14	1	12	20
tPHL	A or B	Q or Q	C _L = 50 pF		6.8	11	1	14	1	12	ns
t _{PLH}			C: - 50 pF		9.2	13	1	16	1	14	ns
t _{PHL}	CLR	Q or Q	$C_L = 50 pF$		9.2	13	1	16	1	14	115
t _{PLH}	<u> </u>	0	C: - 50 pF		9.5	14	1	17	1	15	ns
t _{PHL}	CLR trigger	Q or Q	C _L = 50 pF		9.5	14	1	17	1	15	115
			$C_L = 50 \text{ pF},$ $C_{ext} = 28 \text{ pF},$ $R_{ext} = 2 \text{ k}\Omega$		133	200		240		240	ns
_{tw} †		Q or \overline{Q}	C_L = 50 pF, C_{ext} = 0.01 μ F, R_{ext} = 10 k Ω	90	100	110	90	110	90	110	μs
			C_L = 50 pF, C_{ext} = 0.1 μ F, R_{ext} = 10 k Ω	0.9	1	1.1	0.9	1.1	0.9	1.1	ms
Δt _W ‡					±1						%

operating characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

	PARAMETER	TEST CONDITIONS	TYP	UNIT
C _{pd}	Power dissipation capacitance	No load	29	pF

^{*} On products compliant to MIL-PRF-38535, this parameter is not production tested.
† t_W = Pulse duration at Q and \overline{Q} outputs
‡ Δt_W = Output pulse-duration variation (Q and \overline{Q}) between circuits in same package

PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. All input pulses are supplied by generators having the following characteristics: $Z_0 = 50 \Omega$, $t_f = 3 \text{ ns}$, $t_f = 3 \text{ ns}$.
- C. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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APPLICATION INFORMATION

caution in use

To prevent malfunctions due to noise, connect a high-frequency capacitor between V_{CC} and GND, and keep the wiring between the external components and C_{ext} and R_{ext}/C_{ext} terminals as short as possible.

power-down considerations

Large values of C_{ext} may cause problems when powering down the 'AHCT123A devices because of the amount of energy stored in the capacitor. When a system containing this device is powered down, the capacitor may discharge from V_{CC} through the protection diodes at pin 2 or pin 14. Current through the input protection diodes must be limited to 30 mA; therefore, the turn-off time of the V_{CC} power supply must not be faster than $t = V_{CC} \times C_{ext}/30$ mA. For example, if $V_{CC} = 5$ V and $V_{CC} = 15$ PF, the V_{CC} supply must turn off no faster than $V_{CC} = 15$ V and $V_{CC} = 15$ V and $V_{CC} = 15$ PF, the $V_{CC} = 15$ PF, the V

output pulse duration

The output pulse duration, t_W , is determined primarily by the values of the external capacitance (C_T) and timing resistance (R_T). The timing components are connected as shown in Figure 2.

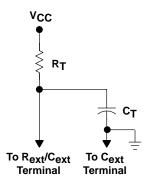


Figure 2. Timing-Component Connections

The pulse duration is given by:

$$t_w = K \times R_T \times C_T$$
 if C_T is \geq 1000 pF, K = 1.0 or if C_T is $<$ 1000 pF, K can be determined from Figure 5

where:

t_w = pulse duration in ns

 R_T = external timing resistance in $k\Omega$

C_T = external capacitance in pF

K = multiplier factor

Equation 1 and Figure 3 can be used to determine values for pulse duration, external resistance, and external capacitance.

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APPLICATION INFORMATION

retriggering data

The minimum input retriggering time (t_{MIR}) is the minimum time required after the initial signal before retriggering the input. After t_{MIR} , the device retriggers the output. Experimentally, it also can be shown that to retrigger the output pulse, the two adjacent input signals should be t_{MIR} apart, where $t_{MIR} = 0.30 \times t_{w}$. The retrigger pulse duration is calculated as shown in Figure 3.

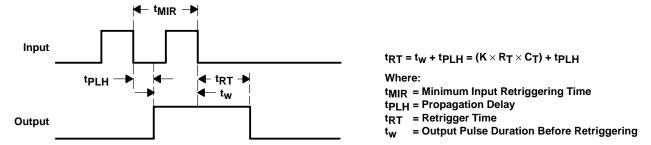
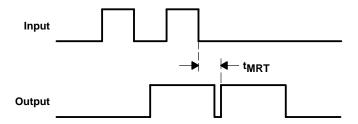


Figure 3. Retrigger Pulse Duration

The minimum value from the end of the input pulse to the beginning of the retriggered output should be approximately 15 ns to ensure a retriggered output (see Figure 4).



 $t_{\mbox{MRT}}$ = Minimum Time Between the End of the Second Input Pulse and the Beginning of the Retriggered Output $t_{\mbox{MRT}}$ = 15 ns

Figure 4. Input/Output Requirements



APPLICATION INFORMATION[†]

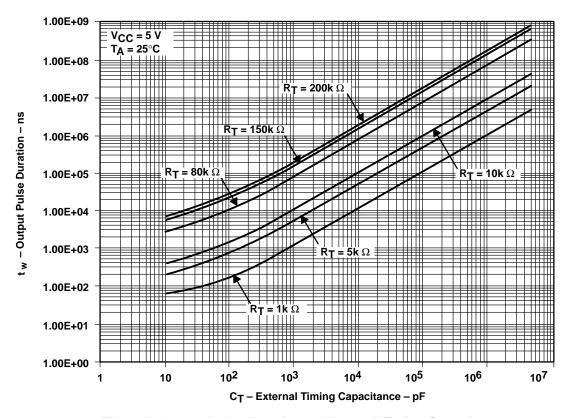


Figure 5. Output Pulse Duration vs External Timing Capacitance

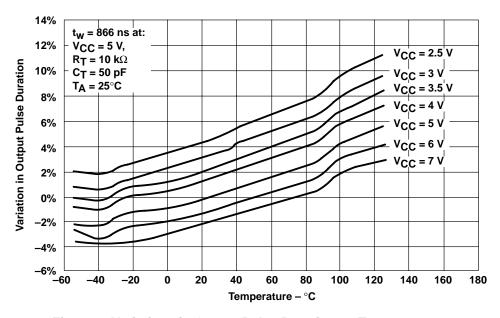
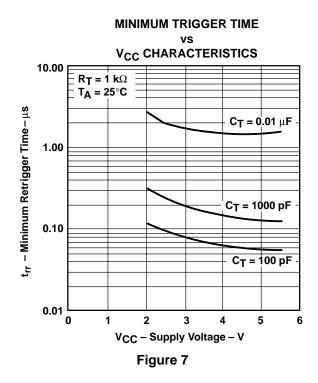


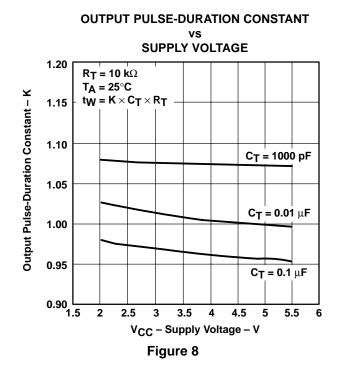
Figure 6. Variations in Output Pulse Duration vs Temperature

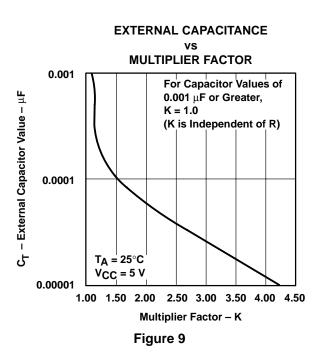
[†] Operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied.

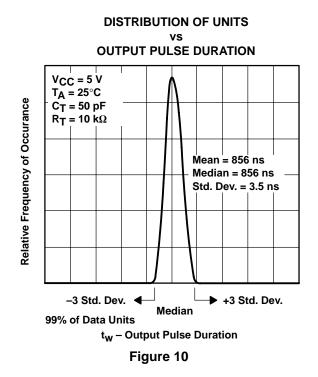


APPLICATION INFORMATION[†]









[†] Operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied.







6-Feb-2020

PACKAGING INFORMATION

Orderable Device	Status	Package Type		Pins	_	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
5962-9861601Q2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	5962- 9861601Q2A SNJ54AHCT 123AFK	Samples
5962-9861601QEA	ACTIVE	CDIP	J	16	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	5962-9861601QE A SNJ54AHCT123AJ	Samples
5962-9861601QFA	ACTIVE	CFP	W	16	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	5962-9861601QF A SNJ54AHCT123AW	Samples
SN74AHCT123AD	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-40 to 85	AHCT123A	Samples
SN74AHCT123ADBR	ACTIVE	SSOP	DB	16	2000	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-40 to 85	HB123A	Samples
SN74AHCT123ADGVR	ACTIVE	TVSOP	DGV	16	2000	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-40 to 85	HB123A	Samples
SN74AHCT123ADR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-40 to 85	AHCT123A	Samples
SN74AHCT123AN	ACTIVE	PDIP	N	16	25	Green (RoHS & no Sb/Br)	NIPDAU	N / A for Pkg Type	-40 to 85	SN74AHCT123AN	Samples
SN74AHCT123APWR	ACTIVE	TSSOP	PW	16	2000	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-40 to 85	HB123A	Samples
SNJ54AHCT123AFK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	5962- 9861601Q2A SNJ54AHCT 123AFK	Samples
SNJ54AHCT123AJ	ACTIVE	CDIP	J	16	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	5962-9861601QE A SNJ54AHCT123AJ	Samples
SNJ54AHCT123AW	ACTIVE	CFP	W	16	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	5962-9861601QF A SNJ54AHCT123AW	Samples

⁽¹⁾ The marketing status values are defined as follows: **ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.



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PACKAGE OPTION ADDENDUM

6-Feb-2020

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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OTHER QUALIFIED VERSIONS OF SN54AHCT123A, SN74AHCT123A:

Catalog: SN74AHCT123A

Military: SN54AHCT123A

NOTE: Qualified Version Definitions:

Catalog - TI's standard catalog product



PACKAGE OPTION ADDENDUM

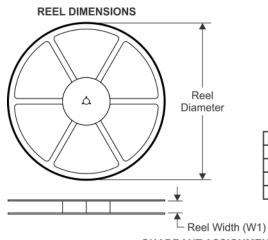
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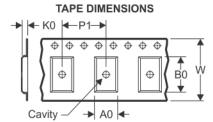
• Military - QML certified for Military and Defense Applications

PACKAGE MATERIALS INFORMATION

www.ti.com 20-Dec-2018

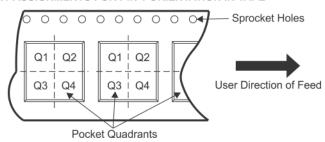
TAPE AND REEL INFORMATION





	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

All difficultions are norminal												
Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74AHCT123ADGVR	TVSOP	DGV	16	2000	330.0	12.4	6.8	4.0	1.6	8.0	12.0	Q1
SN74AHCT123ADR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
SN74AHCT123APWR	TSSOP	PW	16	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1

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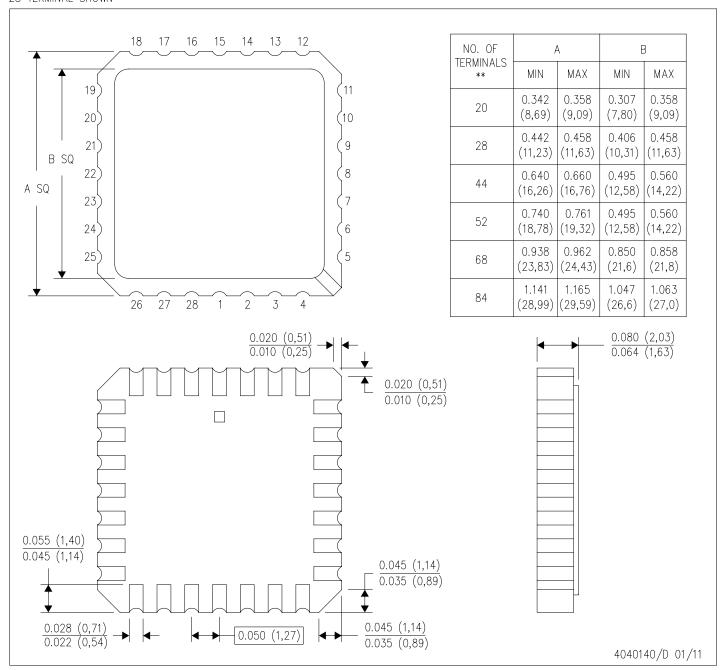
*All dimensions are nominal

7 III GITTIOTIOTOTIO GITO TTOTTIITIGI							
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74AHCT123ADGVR	TVSOP	DGV	16	2000	367.0	367.0	35.0
SN74AHCT123ADR	SOIC	D	16	2500	333.2	345.9	28.6
SN74AHCT123APWR	TSSOP	PW	16	2000	367.0	367.0	35.0

FK (S-CQCC-N**)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN

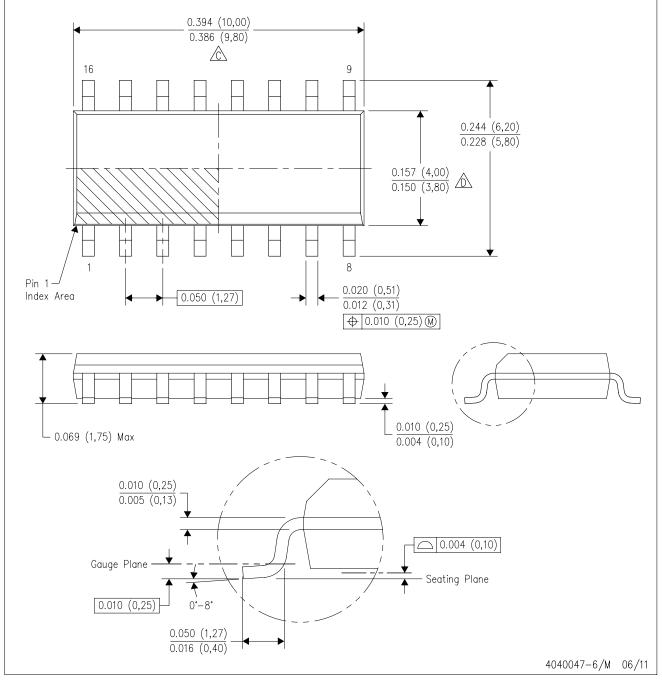


- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. Falls within JEDEC MS-004



D (R-PDS0-G16)

PLASTIC SMALL OUTLINE

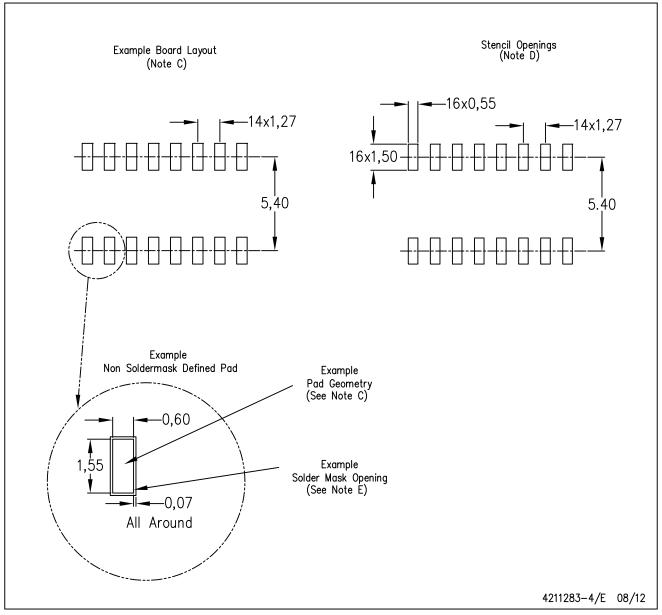


- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



D (R-PDSO-G16)

PLASTIC SMALL OUTLINE

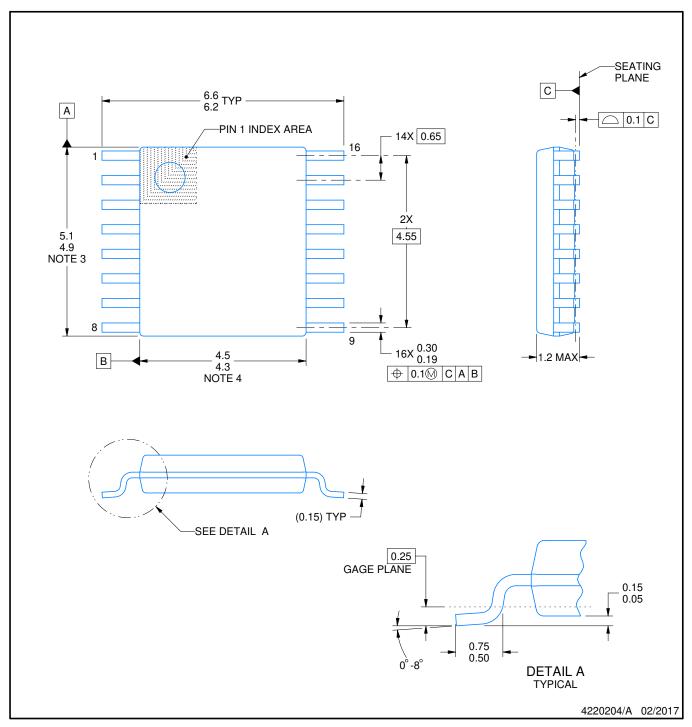


- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.





SMALL OUTLINE PACKAGE



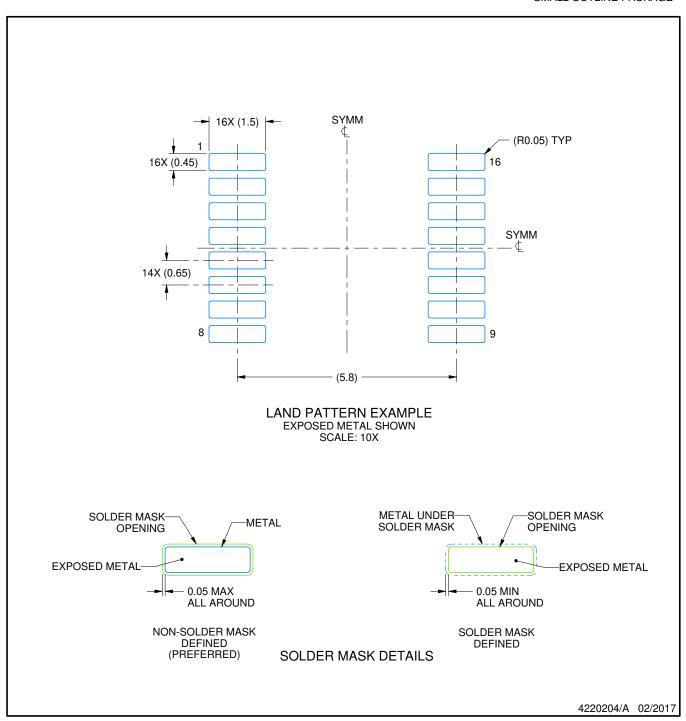
- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

 2. This drawing is subject to change without notice.

 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
- 5. Reference JEDEC registration MO-153.



SMALL OUTLINE PACKAGE



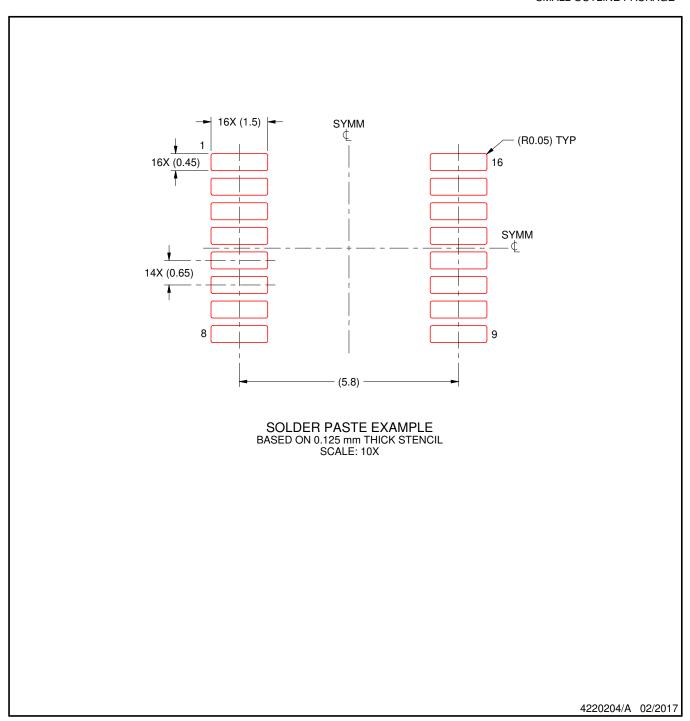
NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE PACKAGE



NOTES: (continued)

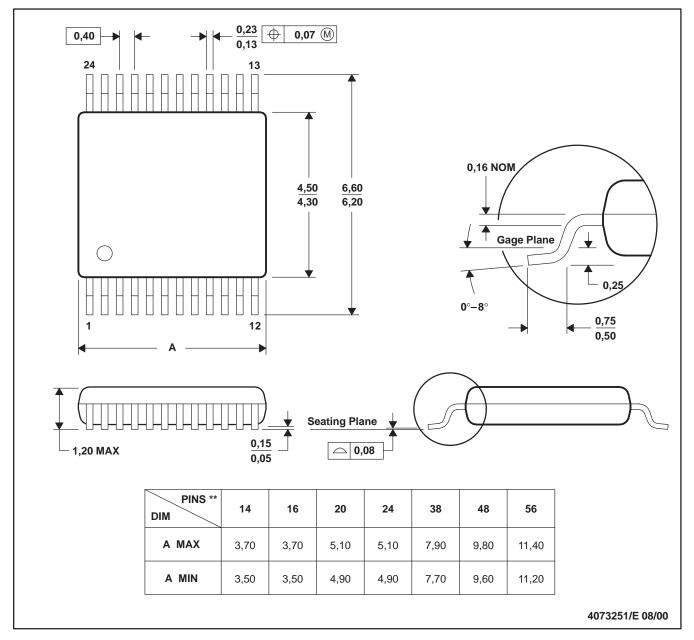
- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



DGV (R-PDSO-G**)

24 PINS SHOWN

PLASTIC SMALL-OUTLINE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

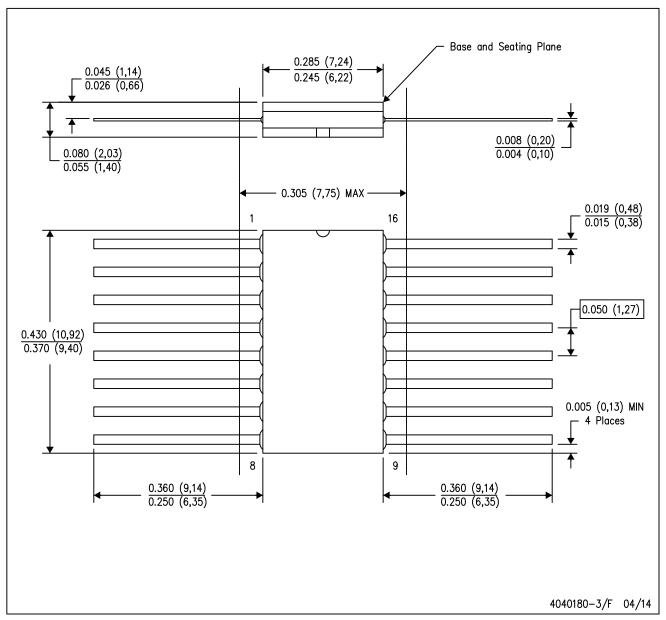
C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.

D. Falls within JEDEC: 24/48 Pins – MO-153 14/16/20/56 Pins – MO-194



W (R-GDFP-F16)

CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP2-F16



14 LEADS SHOWN

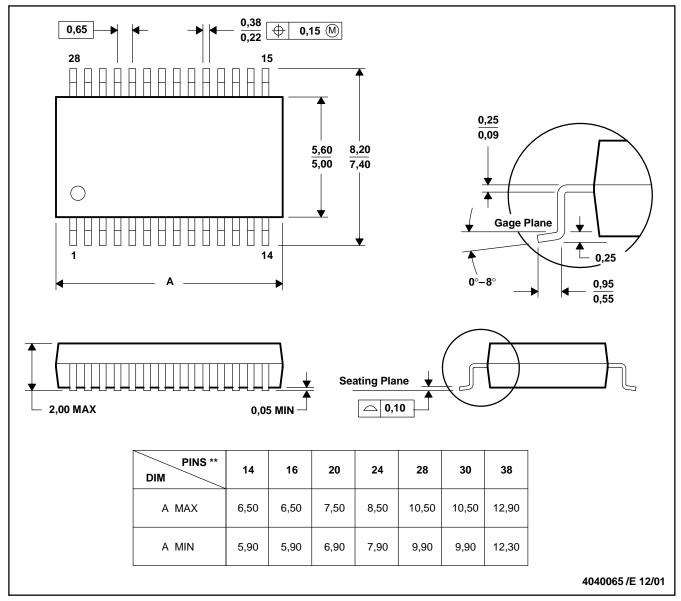


- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

DB (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-150

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



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